

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSIV)

TPCP8202

Portable Equipment Applications

Motor Drive Applications

DC/DC Converters

- Lead (Pb)-free
- Low drain-source ON-resistance: $R_{DS(ON)} = 19 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 20 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 10 \mu\text{A}$ (max) ($V_{DS} = 30 \text{ V}$)
- Enhancement model: $V_{th} = 0.7$ to 1.4 V
($V_{DS} = 10 \text{ V}$, $I_D = 200 \mu\text{A}$)

Absolute Maximum Ratings (Ta = 25°C)

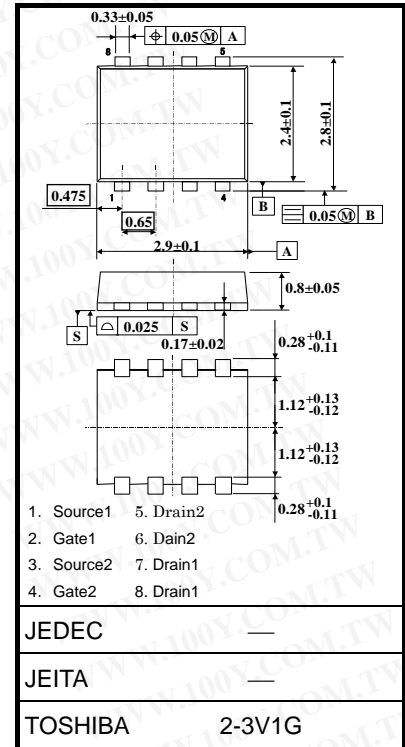
Characteristic		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	30	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	30	V
Gate-source voltage		V_{GSS}	± 12	V
Drain current	DC (Note 1)	I_D	5.5	A
	Pulse (Note 1)	I_{DP}	22	
Drain power dissipation (t = 5 s) (Note 2a)	Single-device operation (Note 3a)	P_D (1)	1.48	W
	Single-device value at dual operation (Note 3b)	P_D (2)	1.23	
Drain power dissipation (t = 5 s) (Note 2b)	Single-device operation (Note 3a)	P_D (1)	0.58	
	Single-device value at dual operation (Note 3b)	P_D (2)	0.36	
Single-pulse avalanche energy (Note 4)		E_{AS}	7.86	mJ
Avalanche current		I_{AR}	5.5	A
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5)		E_{AR}	0.12	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	-55 to 150	°C

Note: For Notes 1 to 6, see the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

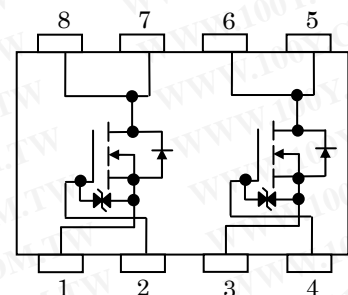
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm

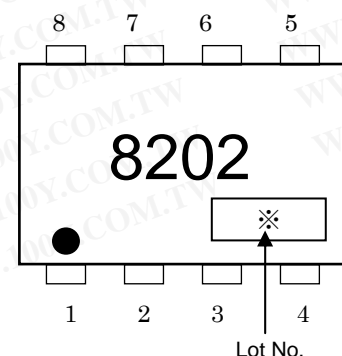


Weight: 0.017 g (typ.)

Circuit Configuration



Marking (Note 6)



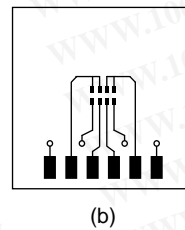
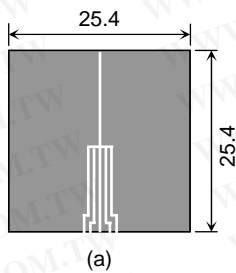
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Thermal Characteristics

Characteristic		Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	Single-device operation (Note 3a)	R _{th (ch-a)} (1)	84.5	°C/W
	Single-device value at dual operation (Note 3b)	R _{th (ch-a)} (2)	101.6	
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	Single-device operation (Note 3a)	R _{th (ch-a)} (1)	215.5	°C/W
	Single-device value at dual operation (Note 3b)	R _{th (ch-a)} (2)	347.2	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



Note 3: a) The power dissipation and thermal resistance values shown are for a single device. (During single-device operation, power is applied to one device only.)

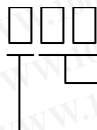
b) The power dissipation and thermal resistance values shown are for a single device. (During dual operation, power is applied to both devices evenly.)

Note 4: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.2 mH, R_G = 25 Ω, I_{AR} = 5.5 A

Note 5: Repetitive rating: Pulse width limited by Max. Channel temperature.

Note 6: ● on the lower left of the marking indicates Pin 1.

* Weekly code (3 digits):



Week of manufacture

(01 for the first week of the year, continuing up to 52 or 53)

Year of manufacture

(The last digit of the calendar year)

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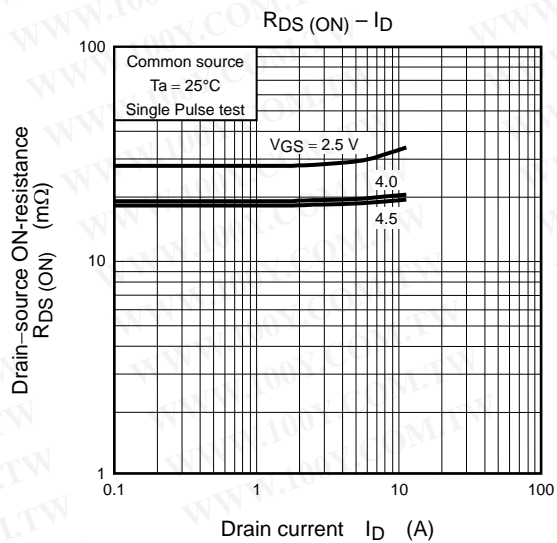
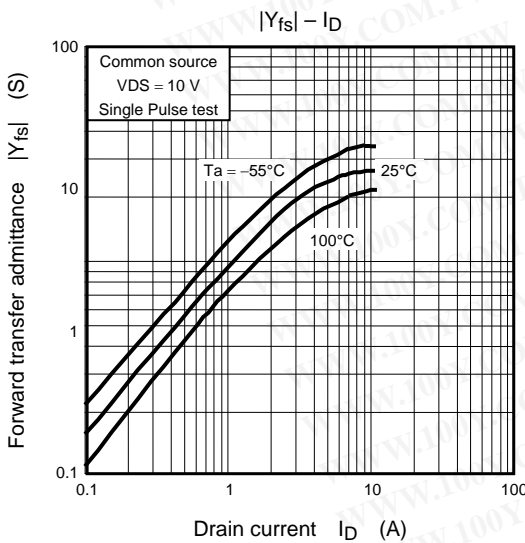
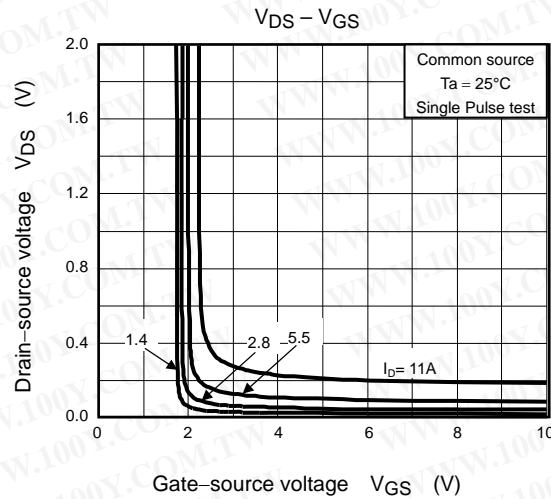
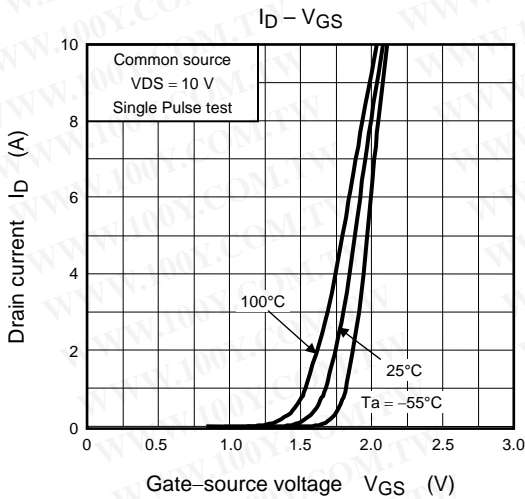
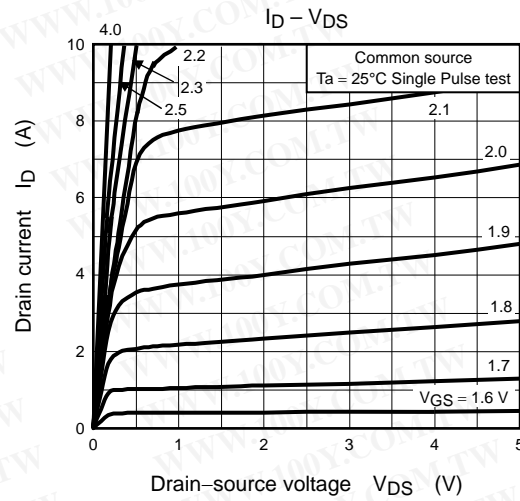
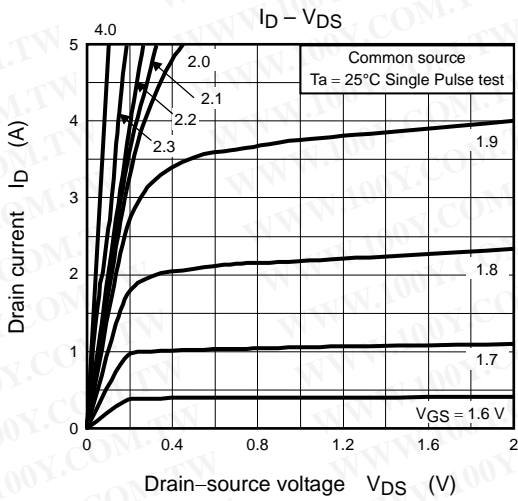
Electrical Characteristics (Ta = 25°C)

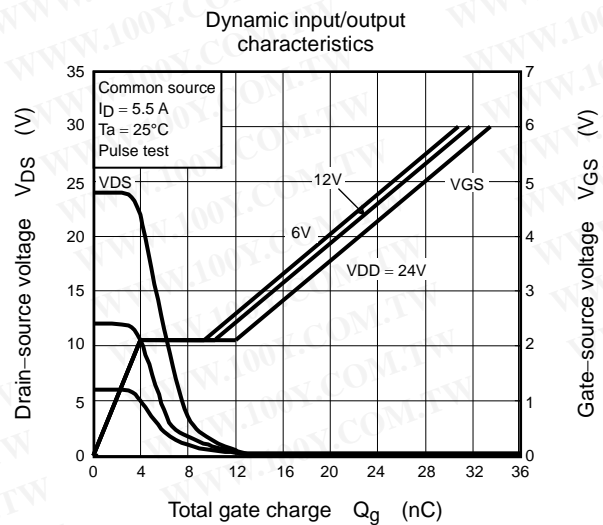
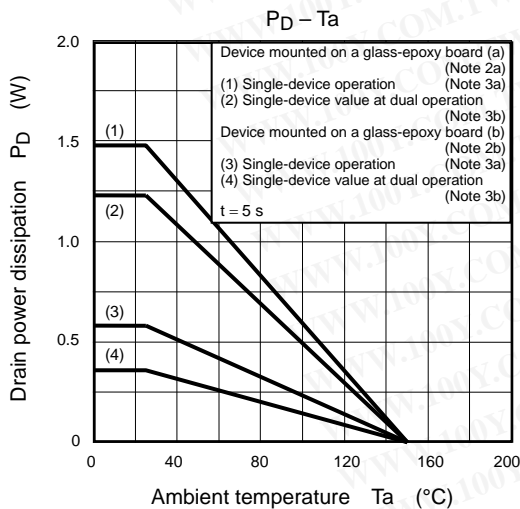
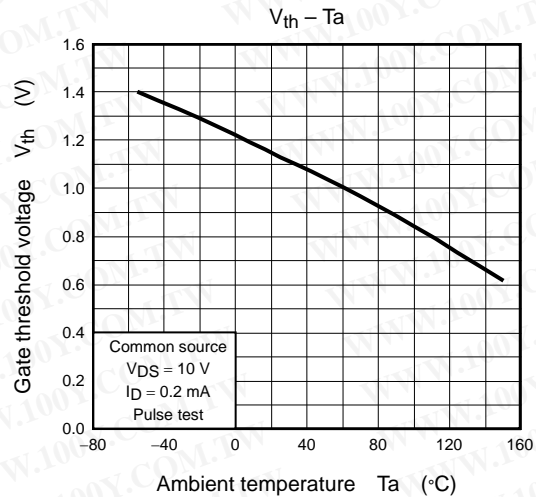
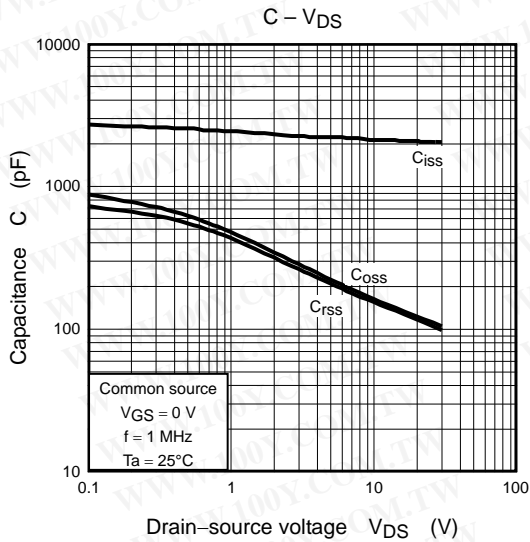
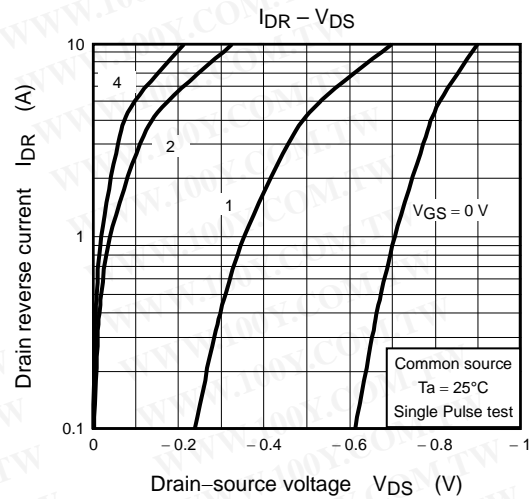
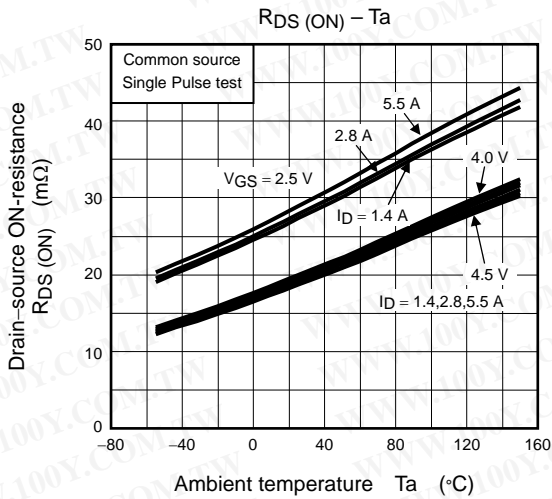
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I _{GSS}	V _{GS} = ±10 V, V _{DS} = 0 V	—	—	±10	μA
Drain cutoff current		I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	—	—	10	μA
Drain-source breakdown voltage		V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	30	—	—	V
		V _{(BR) DSX}	I _D = 10 mA, V _{GS} = -12 V	15	—	—	
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 200 μA	0.7	—	1.4	V
Drain-source ON-resistance		R _{DS (ON)}	V _{GS} = 2.5 V, I _D = 2.8 A	—	29	39	mΩ
		R _{DS (ON)}	V _{GS} = 4.0 V, I _D = 2.8A	—	20	24	
		R _{DS (ON)}	V _{GS} = 4.5 V, I _D = 2.8A	—	19	23	
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 2.8A	10	20	—	S
Input capacitance		C _{iSS}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	—	2150	—	pF
Reverse transfer capacitance		C _{rSS}		—	155	—	
Output capacitance		C _{oSS}		—	165	—	
Switching time	Rise time	t _r		—	10	—	ns
	Turn-on time	t _{on}		—	20	—	
	Fall time	t _f		—	19	—	
	Turn-off time	t _{off}		—	90	—	
Total gate charge (gate-source plus gate-drain)		Q _g	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 5.5 A	—	28	—	nC
Gate-source charge1		Q _{gs1}		—	4	—	
Gate-drain ("Miller") charge		Q _{gd}		—	8	—	

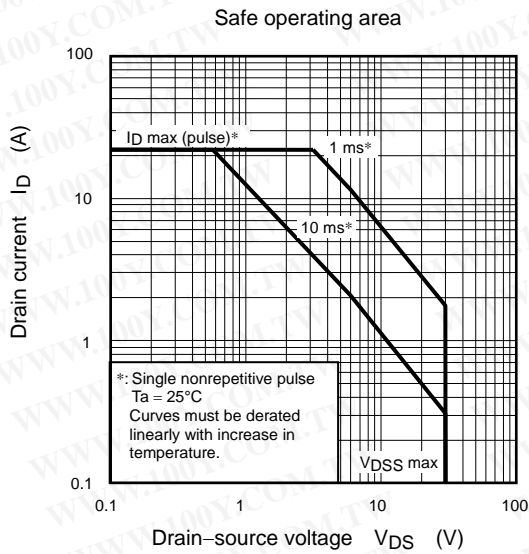
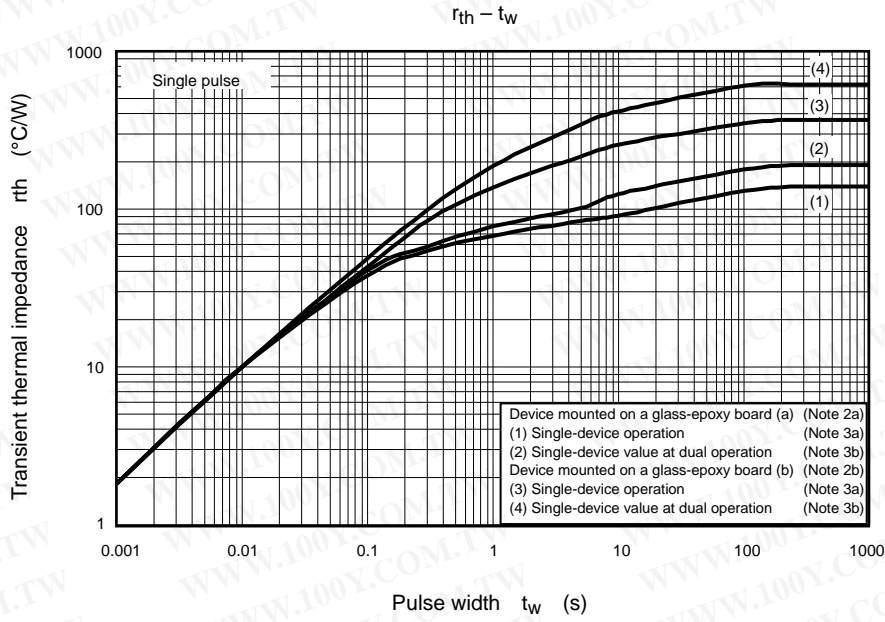
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	—	—	22	A
Forward voltage (diode)		V _{DSF}	I _{DR} = 5.5 A, V _{GS} = 0 V	—	—	-1.2	V

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